### 1.5 A PWM/VFM Buck-Boost DC/DC Converter with Synchronous Rectifier

No. EA-353-190507

## OVERVIEW

The RP602x is a 6.5 V (Max. rating) buck-boost DC/DC converter with synchronous rectifier. This device is ideally suited for industrial or OA equipment that require constant voltage even when low-input voltage (Min. 2.3 V). Since operating with switching frequency of 2.6 MHz , this device can realize a high-speed response with a small coil and maintain a high-efficiency at low input voltage.

## KEY BENEFITS

- Realize a high-efficiency at low input voltage.
- Provide output voltage of 2.7 to 4.2 V corresponding to input voltage of 2.3 to 5.5 V .


## KEYSPECIFICATIONS

- Input Voltage Range:2.3 V to 5.5 V
- Output Voltage Range:2.7 V to 4.2 V (0.1V step)
- Output Voltage Accuracy : $\pm 1.5 \%$
- Line Regulation: Typ. 0.5\%, PWM mode
- Load Regulation: Typ. 0.1\%, (lout $=0$ to $500 \mathrm{~mA}, \mathrm{PWM}$ mode)
- Maximum Output Current: Typ. 1.5 A,

$$
(\mathrm{PVIN}=3 \mathrm{~V}, \mathrm{VOUT}=3.3 \mathrm{~V})
$$

- Maximum Burst Current: Typ. 2.7 A, (PVIN=3 V, VOUT=3.3 V, Duty=10\%, t=2.0 ms)
- Overcurrent Limit Protection: Typ. 4.2 A
- Oscillator Frequency: Typ. 2.6 MHz
- Built-in Driver ON Resistance:

Typ. Pch. $80 \mathrm{~m} \Omega$, Nch. $80 \mathrm{~m} \Omega$

- Operating Quiescent Current: Typ. $27.5 \mu \mathrm{~A}$,
(VFM mode, Non-switching)
- UVLO Detector Threshold: Typ. 2.0 V
- Soft-start Time: Typ. 1.0 ms
- Thermal Shutdown Temperature:Typ. $150^{\circ} \mathrm{C}$
- Protection Feature: Overvoltage, Overcurrent


## PACKAGE

RP602Z
RP602K


DFN(PLP)2730-12 $2.7 \mathrm{~mm} \times 3.0 \mathrm{~mm}$

TYPICAL CHARACTERISTICS


Efficiency Characterisitcs (RP602Z330x, MODE = H)


## OPTIONAL FUNCTION

The following functions are user-selectable options.

| Code | Auto-discharge <br> Function | Latch <br> Protection | Reset <br> Protection |
| :---: | :---: | :---: | :---: |
| A/E | Yes | Yes | No |
| B/F | No | Yes | No |
| C/G | Yes | No | Yes |
| D/H | No | No | Yes |

## APPLICATIONS

- Power source for portable equipment such as laptops, PDAs, DSCs, cellular phones, and smartphones
- Power source for Li-ion battery-used equipment


## RP602x

No. JA-353-190507

## SELECTION GUIDE

Selection Guide

| Product Name | Package | Quantity per Reel | Pb Free | Halogen Free |
| :---: | :---: | :---: | :---: | :---: |
| RP602Zxxx\$-E2-F | WLCSP-20-P1 | $5,000 \mathrm{pcs}$ | Yes | Yes |
| RP602Kxxx\#-TR | DFN(PLP)2730-12 | $5,000 \mathrm{pcs}$ | Yes | Yes |

xxx : Specify the set output voltage $\left(\mathrm{V}_{\mathrm{SET}}\right)$ within the range of 2.7 V to 4.2 V in $0.1 \mathrm{~V}{ }^{(1)}$ steps.
\$: Specify the combination of the auto-discharge option and the protection function option.

| Symbol | Auto-discharge <br> Function | Latch-type <br> Protection | Reset-type <br> Protection | Short-circuit <br> Protection |
| :---: | :---: | :---: | :---: | :---: |
| A | Yes | Yes | No | Yes |
| B | No | Yes | No | Yes |
| C | Yes | No | Yes | Yes |
| D | No | No | Yes | Yes |

\#: Specify the combination of the auto-discharge option and the protection function option.

| Symbol | Auto-discharge <br> Function | Latch-type <br> Protection | Reset-type <br> Protection | Short-circuit <br> Protection |
| :---: | :---: | :---: | :---: | :---: |
| E | Yes | Yes | No | Yes |
| F | No | Yes | No | Yes |
| G | Yes | No | Yes | Yes |
| H | No | No | Yes | Yes |

(1) 0.05 V step is also available as a custom code.

## BLOCK DIAGRAM



RP602x Block Diagram

## RP602x

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## PIN DESCRIPTION

## RP602Z Pin Description



WLCSP-20-P1 Pin Configuration

| Pin No. | Symbol | Pin Description |
| :---: | :---: | :--- |
| A5, B5, C5 | VOUT $^{(1)}$ | Output Voltage Pin |
| A4, B4, C4 | BOLX $^{(1)}$ | Boost Switching Output Pin |
| A3, B3, C3 | PGND $^{(2)}$ | Power GND Pin |
| A2, B2, C2 | BULX $^{(1)}$ | Buck Switching Output Pin |
| A1, B1, C1 | PVIN $^{(1)}$ | Power Input Voltage Pin |
| D1 | AVIN $^{(1)}$ | Analog Power Input Voltage Pin |
| D2 | CE | Chip Enable Pin, Active-high |
| D3 | MODE | Mode Control Pin, <br> Forced PWM Control: L, PWM/VFM Auto Switching Control: H |
| D4 | AGND ${ }^{(2)}$ | Analog GND Pin |
| D5 | VFB | Output Voltage Feedback Pin |

Pin Truth Table

| CE Pin | MODE Pin ${ }^{(3)}$ | Operation |
| :---: | :---: | :---: |
| L | - | OFF |
| H | H | PWM/ VFM Auto Switching Control Mode |
|  | L | Forced PWM Control Mode |

[^0]
## RP602K Pin Description

Top View


## Bottom View



DFN(PLP)2730-12 Pin Configuration

| Pin No. | Symbol | Pin Description |
| :---: | :---: | :--- |
| 1 | AVIN $^{(1)}$ | Analog Power Input Voltage Pin |
| 2 | CE | Chip Enable Pin, Active-high |
| 3 | MODE | Mode Control Pin, <br> Forced PWM Control: L, PWM/VFM Auto Switching Control: H |
| 4 | NC | No Connection |
| 5 | AGND ${ }^{(2)}$ | Analog GND Pin |
| 6 | VFB | Output Voltage Feedback Pin |
| 7 | VOUT | Output Voltage Pin |
| 8 | BOLX | Boost Switching Output Pin |
| 9,10 | PGND ${ }^{(2)}$ | Power GND Pin |
| 11 | BULX | Buck Switching Output Pin |
| 12 | PVIN ${ }^{(1)}$ | Power Input Voltage Pin |

* The tab on the bottom of the package must be connected to the ground plane on the board to enhance thermal performance.

Pin Truth Table

| CE Pin | MODE Pin ${ }^{(3)}$ | Operation |
| :---: | :---: | :---: |
| L | - | OFF |
| H | H | PWM/ VFM Auto Switching Control Mode |
|  | L | Forced PWM Control Mode |

[^1]
## RP602x

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## ABSOLUTE MAXIMUM RATINGS

| Absolute Maximum Ratings |  |  | $(\mathrm{AGND}=\mathrm{PGND}=0 \mathrm{~V})$ |  |
| :---: | :---: | :---: | :---: | :---: |
| Symbol |  | Item | Rating | Unit |
| Vin | AVIN/ PVIN Pin Voltage |  | -0.3 to 6.5 | V |
| Vbulx | BULX Pin Voltage |  | -0.3 to $\mathrm{V}_{\mathbf{1}}+0.3$ | V |
| Vbolx | BOLX Pin Voltage |  | -0.3 to $\mathrm{V}_{\text {Out }}+0.3$ | V |
| $V_{\text {ce }}$ | CE Pin Voltage |  | -0.3 to 6.5 | V |
| Vmode | MODE Pin Voltage |  | -0.3 to 6.5 | V |
| Vout | VOUT Pin Voltage |  | -0.3 to 6.5 | V |
| $V_{\text {fb }}$ | VFB Pin Voltage |  | -0.3 to 6.5 | V |
| ILX | BULX/ BOLX Pin Output Current |  | 4.2 | A |
| PD | Power Dissipation ${ }^{(1)}$ | WLCSP-20-P1 <br> (JEDEC STD.51-9) | 1400 | mW |
|  |  | $\begin{aligned} & \text { DFN(PLP)2730-12 } \\ & \text { (JEDEC STD.51-7) } \end{aligned}$ | 3100 |  |
| Tj | Junction Temperature Range |  | -40 to 125 | ${ }^{\circ} \mathrm{C}$ |
| Tstg | Storage Temperature Range |  | -55 to 125 | ${ }^{\circ} \mathrm{C}$ |

## ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the life time and safety for both device and system using the device in the field.
The functional operation at or over these absolute maximum ratings are not assured.

## RECOMMENDED OPERATING CONDITIONS

| Symbol | Item | Rating | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathbb{N}}$ | Input Voltage | 2.3 to 5.5 | V |
| Ta | Operating Temperature Range | -40 to 85 | ${ }^{\circ} \mathrm{C}$ |

## RECOMMENDED OPERATING CONDITIONS


#### Abstract

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such ratings by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.


[^2]
## ELECTRICAL CHARACTERISTICS

Open-loop Measurement GND $=0 \mathrm{~V}$, unless otherwise noted.

| RP602Z Electrical Characteristics |  | $\left(\mathrm{Ta}=25^{\circ} \mathrm{C}\right)$ |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol | Item | Condit | tions | Min. | Typ. | Max. | Unit |
| Ido | Power Current | $\mathrm{V}_{\text {IN }}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\text {MOde }}=5.5 \mathrm{~V}$ |  | 27.5 | 60 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {OUT }}=4.2 \mathrm{~V}$ | $\mathrm{V}_{\text {Mode }}=0 \mathrm{~V}$ |  | 1000 | 1400 |  |
| Istandby | Standby Current | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}$ | $\mathrm{V}_{\text {CE }}=0 \mathrm{~V}$ |  | 0.1 | 5.0 | $\mu \mathrm{A}$ |
| Vout | Output Voltage | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$ |  | x0.985 |  | $\times 1.015$ | V |
| $\Delta$ Vout $I \Delta T a$ | Output Voltage Temperature Coefficient | $-40^{\circ} \mathrm{C} \leq \mathrm{Ta} \leq 85^{\circ} \mathrm{C}$ |  |  | $\pm 50$ |  | $\mathrm{ppm}^{\circ} \mathrm{C}$ |
| Vovp | OVP Detection Voltage | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$, Rising |  | 4.5 | 5.0 | 5.5 | V |
|  | OVP Release Voltage | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$, Falling |  | 4.3 | 4.8 | 5.3 | V |
| fosc | Switching Frequency | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$ |  | 2.4 | 2.6 | 2.9 | MHz |
| lııмнS | BULX Current Limit ${ }^{(1)}$ | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$ |  | 3.7 | 4.2 |  | A |
| Ron | High \& Low Switch On-resistance | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$ |  |  | 80 |  | $\mathrm{m} \Omega$ |
| R ${ }_{\text {dis }}$ | On-resistance of Discharge Tr. (RP602ZxxxA/C) | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {CE }}=0 \mathrm{~V}$ |  |  | 80 |  | $\Omega$ |
| Ifbe | $V_{\text {FB }}$ Input Current, High | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{FB}}=5.5 \mathrm{~V} \end{aligned}$ |  |  |  | 1 | $\mu \mathrm{A}$ |
| Ifbl | $V_{\text {FB }}$ Input Current, Low | $\begin{aligned} & V_{\mathbb{I N}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{FB}}=0 \mathrm{~V} \end{aligned}$ |  |  |  | 1 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\mathrm{H}}$ | CE / MODE Pins Input Voltage, High | $\mathrm{V}_{1 \mathrm{I}}=5.5 \mathrm{~V}$ |  | 1.0 |  |  | V |
| $\mathrm{V}_{\mathrm{L}}$ | CE / MODE Pins Input Voltage, Low | $\mathrm{V}_{1 \mathrm{~N}}=2.3 \mathrm{~V}$ |  |  |  | 0.4 | V |
| $\mathrm{IH}^{\text {r }}$ | CE / MODE Pins Input Current, High | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {CE }}=5.5 \mathrm{~V}$ |  | -1 | 0 | 1 | $\mu \mathrm{A}$ |
| IL | CE / MODE Pins Input Current, Low | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}, \mathrm{~V}_{\text {CE }}=0 \mathrm{~V}$ |  | -1 | 0 | 1 | $\mu \mathrm{A}$ |
| Vuvlo1 | UVLO Detection Voltage | $\mathrm{V}_{\mathrm{IN}}=$ Falling |  | 1.83 | 2.00 |  | V |
| Vuvioz | UVLO Release Voltage | $\mathrm{V}_{\text {IN }}=$ Rising |  |  | 2.05 | 2.25 | V |
| TTSD | Thermal Shutdown Threshold Temperature | Tj, Rising |  |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
| TTSR |  | Tj, Falling |  |  | 110 |  | ${ }^{\circ} \mathrm{C}$ |
| tstart | Soft-start Time | $\mathrm{V}_{1 \times}=3.6 \mathrm{~V}$ |  |  | 1 |  | ms |
| tprot | Protection Delay Time (RP602ZxxxA/B/C/D) | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ |  |  | 1.6 |  | ms |
| $t_{\text {RSt }}$ | Reset Protection Delay Time (RP602ZxxxC/D) | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ |  |  | 12 |  | ms |

All test items listed under ELECTRICAL CHARACTERISTICS are done under the pulse load condition $\left(\mathrm{Tj} \approx \mathrm{Ta}=25^{\circ} \mathrm{C}\right)$.
${ }^{(1)}$ BULX Current Limit vary according to the switching duty ratio.

## RP602x

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Open-loop Measurement GND $=0 \mathrm{~V}$, unless otherwise noted.

| RP602K Electrical Characteristics |  |  |  |  |  | $\left(\mathrm{Ta}=25^{\circ} \mathrm{C}\right)$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Symbol | Item | Conditions |  | Min. | Typ. | Max. | Unit |
| lod | Power Current | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$, | $\mathrm{V}_{\text {MODE }}=5.5 \mathrm{~V}$ |  | 27.5 | 60 | $\mu \mathrm{A}$ |
|  |  | $V_{\text {out }}=4.2 \mathrm{~V}$, | $\mathrm{V}_{\text {mode }}=0 \mathrm{~V}$ |  | 1000 | 1400 |  |
| Istanoby | Standby Current | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}$ | E $=0 \mathrm{~V}$ |  | 0.1 | 5.0 | $\mu \mathrm{A}$ |
| Vout | Output Voltage | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ |  | x0.985 |  | $\times 1.015$ | V |
| $\Delta$ Vout $I \Delta \mathrm{Ta}$ | Output Voltage Temperature Coefficient | $-40^{\circ} \mathrm{C} \leq \mathrm{Ta} \leq 85^{\circ} \mathrm{C}$ |  |  | $\pm 50$ |  | $\begin{aligned} & \hline \mathrm{ppm} / \\ & { }^{\circ} \mathrm{C} \end{aligned}$ |
| Vovp | OVP Detection Voltage | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$, Rising |  | 4.5 | 5.0 | 5.5 | V |
|  | OVP release Voltage | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$, Falling |  | 4.3 | 4.8 | 5.3 | V |
| fosc | Switching Frequency | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ |  | 2.4 | 2.6 | 2.9 | MHz |
| lııмнS | BULX Current Limit ${ }^{(1)}$ | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$ |  | 3.7 | 4.2 |  | A |
| Ron | High \& Low Switch On-resistance | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ |  |  | 120 |  | $\mathrm{m} \Omega$ |
| Rois | On-resistance of Discharge Tr. (RP602KxxxE/G) | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {CE }}=0 \mathrm{~V}$ |  |  | 80 |  | $\Omega$ |
| Іfвн | $V_{\text {FB }}$ Input Current, High | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{FB}}=5.5 \mathrm{~V} \end{aligned}$ |  |  |  | 1 | $\mu \mathrm{A}$ |
| Ifbl | VFb Input Current, Low | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CE}}=0 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{FB}}=0 \mathrm{~V} \end{aligned}$ |  |  |  | 1 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\mathrm{H}}$ | CE / MODE Pins Input Voltage, High | $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$ |  | 1.0 |  |  | V |
| VL | CE / MODE Pins Input Voltage, Low | $\mathrm{V}_{1 \times}=2.3 \mathrm{~V}$ |  |  |  | 0.4 | V |
| $\mathrm{IH}^{\text {}}$ | CE / MODE Pins Input Current, High | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {CE }}=5.5 \mathrm{~V}$ |  | -1 | 0 | 1 | $\mu \mathrm{A}$ |
| IL | CE / MODE Pins Input Current, Low | $\mathrm{V}_{\text {IN }}=5.5 \mathrm{~V}, \mathrm{~V}_{\text {ce }}=0 \mathrm{~V}$ |  | -1 | 0 | 1 | $\mu \mathrm{A}$ |
| Vuvlo1 | UVLO Detection Voltage | $\mathrm{V}_{\mathrm{IN}}=$ Falling |  | 1.83 | 2.00 |  | V |
| Vuvior | UVLO Release Voltage | $\mathrm{V}_{\text {IN }}=$ Rising |  |  | 2.05 | 2.25 | V |
| T TsD | Thermal Shutdown Threshold Temperature | Tj, Rising |  |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
| TTSR |  | Tj, Falling |  |  | 110 |  | ${ }^{\circ} \mathrm{C}$ |
| tstart | Soft-start Time | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$ |  |  | 1 |  | ms |
| tprot | Protection Delay Time (RP602KxxxE/F/G/H) | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ |  |  | 1.6 |  | ms |
| trst | Reset Protection Delay Time (RP602KxxxG/H) | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ |  |  | 12 |  | ms |

All test items listed under ELECTRICAL CHARACTERISTICS are done under the pulse load condition ( $\mathrm{T} \boldsymbol{\mathrm { j }} \approx \mathrm{Ta}=25^{\circ} \mathrm{C}$ ).
${ }^{(1)}$ BULX Current Limit vary according to the switching duty ratio.
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RP602x
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Product-specific Electrical Characteristics
$\left(\mathrm{Ta}=25^{\circ} \mathrm{C}\right)$

| Product Name | Vout (V) |  |  |
| :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |
| RP602x270x | 2.660 | 2.700 | 2.740 |
| RP602x280x | 2.758 | 2.800 | 2.842 |
| RP602x290x | 2.857 | 2.900 | 2.943 |
| RP602x300x | 2.955 | 3.000 | 3.045 |
| RP602x310x | 3.054 | 3.100 | 3.146 |
| RP602x320x | 3.152 | 3.200 | 3.248 |
| RP602x330x | 3.251 | 3.300 | 3.349 |
| RP602x340x | 3.349 | 3.400 | 3.451 |
| RP602x350x | 3.448 | 3.500 | 3.552 |
| RP602x360x | 3.546 | 3.600 | 3.654 |
| RP602x370x | 3.645 | 3.700 | 3.755 |
| RP602x380x | 3.743 | 3.800 | 3.857 |
| RP602x390x | 3.842 | 3.900 | 3.958 |
| RP602x400x | 3.940 | 4.000 | 4.060 |
| RP602x410x | 4.137 | 4.100 | 4.161 |
| RP602x420x | 4.200 | 4.263 |  |

## RP602x

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## THEORY OF OPERATION

## Soft-start Time

## Starting-up with CE Pin

The IC starts to operate when the CE pin voltage ( $\mathrm{V}_{\mathrm{CE}}$ ) exceeds the threshold voltage. The threshold voltage is preset between CE "High" input voltage ( V сен) and CE "Low" input voltage ( $\mathrm{V}_{\text {cel }}$ ). After the start-up of the IC, soft-start circuit starts to operate. Then, after a certain period of time, the reference voltage (VREF) in the IC gradually increases up to the specified value. Soft-start time (tstart) starts when soft-start circuit is activated, and ends when the reference voltage reaches the specified voltage. Soft start time is not always equal to the turn-on speed of the DC/DC converter. Note that the turn-on speed could be affected by the power supply capacity, the output current, the inductance value and the Cout value.


## Timing Chart: Starting-up with CE Pin

## Starting-up with Power Supply

After the power-on, when VIN exceeds the UVLO release voltage (VuvLO2), the IC starts to operate. Then, softstart circuit starts to operate and after a certain period of time, Vref gradually increases up to the specified value. Soft-start time starts when soft-start circuit is activated, and ends when $V_{\text {REF }}$ reaches the specified voltage. Note that the turn-on speed of Vout could be affected by the power supply capacity, the output current, the inductance value, the Cout value and the turn-on speed of $\mathrm{V}_{\text {IN }}$ determined by $\mathrm{C}_{\mathrm{IN}}$.


Timing Chart: Starting-up with Power Supply

## Undervoltage Lockout (UVLO) Circuit

If the Vin becomes lower than the UVLO detection voltage (Vuvlo1), the UVLO circuit starts to operate, Vref stops, and P-channel and N -channel built-in switch transistors turn "OFF". As a result, Vout drops according to the Cout capacitance value and the load. To restart the operation, Vin needs to be higher than Vuvloz.

## Overvoltage Protection (OVP) Circuit

If the Vout becomes higher than the OVP detection voltage (Vovp), the OVP circuit starts to operate, P-channel and N -channel built-in switch transistors turn "OFF". As a result, Vout drops according to the Cout capacitance value and the load.

## Overcurrent Protection Circuit

Overcurrent protection circuit supervises the inductor peak current (the peak current flowing through Pch Tr (SW1) in each switching cycle, and if the current exceeds the BULX current limit (lıxLIm), it turns off Pch Tr (SW1). ILxLim of the RP602x is set to Typ. 4200 mA.


## Simplified Diagram of Output Switches

## Short Protection Circuit

If the Vout becomes lower than a certain threshold, the BULX current limit is reduced.


Timing Chart: Overcurrent Protection Circuit \& Short Protection Circuit

## RP602x

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## Latch Type Protection Circuit: RP602xxxxA/B/E/F

The latch type protection circuit latches the built-in drivers of SW1, SW2, SW3 and SW4 off to stop the operation of the device if the overcurrent state continues more than the protection delay time ( $t_{\text {PRot }}$ ).

To release the latch-type protection, reset the device by switching the CE pin from High to Low or making the input voltage $\left(\mathrm{V}_{\mathrm{IN}}\right)$ lower than the UVLO detection voltage (VuvLo1).


Timing Chart: RP602xxxxA/B/E/F Latch Protection Circuit

## Reset Type Protection Circuit: RP602xxxxC/D/G/H

When the overcurrent state continues more than the protection delay time (tprot), the reset type protection circuit operates and switching stops. The built-in drivers of SW1, SW2, SW3 and SW4 turn off and restarts after the reset protection delay time (tRST). When the overcurrent state is released, the operation is automatically released and returns to normal operation.


Timing Chart: RP602xxxxC/D/G/H Reset Protection Circuit

## RP602x

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## APPLICATION INFORMATION



RP602x Typical Application Circuit
Recommended External Components

| Symbol | Description |
| :---: | :--- |
| $\mathrm{C}_{\text {IN }}{ }^{(1)}$ | $10 \mu \mathrm{~F}$, Ceramic, GRM188R60J106ME47, Murata |
| Cout $^{(2)}$ | $22 \mu \mathrm{~F} \times$ 2, Ceramic, GRM188R60J226MEA0, Murata |
| L | $1.0 \mu \mathrm{H}$, Inductor, DFE201610P- 1R0M, TOKO |
|  | $1.0 \mu \mathrm{H}$, Inductor, XAL4020- 102ME, Coilcraft |

## Technical Notes on External Components Selection

- Use ceramic capacitors having a low equivalent series resistance (ESR). Cout should be paralleled with another Cout. When selecting the capacitors, consider the bias characteristics and input/ output voltage.
- When the built-in switches are turned off, the inductor may generate a spike-shaped high voltage. Use the high-breakdown voltage capacitor (Cout) which output voltage is 1.5 times or more than the set output voltage.
- Use an inductor that has a low DC resistance, has an enough tolerable current and is less likely to cause magnetic saturation. If the inductance value is extremely small, the peak current of LX may increase. When the peak current of LX reaches to the LX limit current (LLxLIM), overcurrent protection circuit starts to operate. When selecting the inductor, consider the peak current of LX pin (lıxmax). Refer to Calculation Method of Peak Current of LX Pin (ILхмах) in Continuous Mode for details.

[^3]
## Calculation Method of Peak Current of LX Pin (llxmax) in Continuous Mode

The peak current of LX pin (lıXMAX) can be calculated as follows, in the case of an ideal buck converter operating in steady conditions, using the components listed in Recommended External Components of APPLICATION INFORMATION.

Ripple Current P-P value is described as IRP, ON resistance of Pch. Tr. is described as RonP, ON resistance of Nch. Tr. is described as Ronn, and DC resistor of the inductor is described as RL.

First, when Pch. Tr. is "ON", the following equation is satisfied.
$V_{I N}=V_{\text {OUT }}+\left(R_{\text {ONP }}+R_{L}\right) \times I_{\text {OUT }}+L \times I_{R P} /$ ton.
Equation 1

Second, when Pch. Tr. is "OFF" (Nch. Tr. is "ON"), the following equation is satisfied.
$L \times I_{R P} /$ tofF $=R_{\text {ONN }} \times$ lout $+V_{\text {OUT }}+R_{L} \times$ lout.............................................................................. Equation 2

Put Equation 2 into Equation 1 to solve ON duty of Pch. Tr. (Don $=$ ton $/($ toff + ton $)$ ):


Ripple Current is described as follows:
$I_{R P}=\left(V_{\text {IN }}-V_{\text {OUT }}-R_{\text {ONP }} \times\right.$ lout $-R_{L} \times$ lout $) \times D_{\text {ON }} /$ fosc $/ L$
Equation 4

Peak current that flows through $L$, and LX Tr. is described as follows:
$I_{\text {Lx }} \max =\mathrm{l}_{\mathrm{OUT}}+\mathrm{I}_{\mathrm{RP}} / 2$.
Equation 5

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The peak current of LX pin (llxmax) can be calculated as follows, in the case of an ideal boost converter operating in steady conditions, using the components listed in Recommended External Components of APPLICATION INFORMATION.

Ripple Current P-P value is described as IRP, Average inductor current is described as ILx, ON resistance of Pch. Tr. and ON resistance of Nch. Tr. is described as Ronp and Ronn respectively, and DC resistor of the inductor is described as RL.

First, when Nch. Tr. is "ON", the following equation is satisfied.
$L \times I_{R P} /$ ton $=V_{I N}-\left(R_{L}+R_{o n N}\right) \times I_{L x}$
Equation 6

Second, when Nch. Tr. is "OFF" (Pch. Tr. is "ON"), the following equation is satisfied.
$L \times I_{\text {RP }} /$ toff $=V_{\text {OUT }}+\left(R_{L}+R_{\text {ONP }}\right) \times I_{L X}-V_{I N}$ Equation 7

Put Equation 7 into Equation 6 to solve ON duty of Nch . $\operatorname{Tr}$. ( $\mathrm{Don}_{\mathrm{on}}=\mathrm{ton} /(\mathrm{tofF}+\mathrm{t}$ ton $)$ ):
$\mathrm{D}_{\text {ON }}=\left(\mathrm{V}_{\text {OUT }}-\mathrm{V}_{\mathrm{IN}}+\mathrm{R}_{\mathrm{L}} \times \mathrm{I}_{\mathrm{LX}}+\mathrm{R}_{\text {ONP }} \times \mathrm{I}_{\mathrm{LX}}\right) /\left(\mathrm{V}_{\text {OUT }}+\mathrm{R}_{\text {ONP }} \times \mathrm{I}_{\mathrm{LX}}-\mathrm{R}_{\text {ONN }} \times \mathrm{I}_{\mathrm{LX}}\right)$
Equation 8

Ripple Current is described as follows:
$I_{R P}=\left(V_{I N}-R_{L} \times I_{L X}-R_{\text {ONN }} \times I_{L X}\right) \times D_{\text {oN }} / f_{\text {OSc }} / L$
Equation 9

Peak current that flows through L (llmax), and LX Tr. is described as follows:
$I_{\text {LXMAX }}=I_{\text {LX }}+I_{\text {RP }} / 2$. Equation 10

Also, the average peak current (lout and Don) in the boost circuit is described as follows:

ILX $=$ lout $/(1-$ Don $)$
Equation 11

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## TECHNICAL NOTES

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. A peripheral component or the device mounted on PCB should not exceed a rated voltage, a rated current or a rated power. When designing a peripheral circuit, please be fully aware of the following points.

- Place the bypass capacitor ( $\mathrm{C}_{\mathrm{IIN}}$ ) between the PVIN pin and the GND pin with shortest-distance wiring.
- Place the output capacitor (Cout) between the Vоит pin and the GND pin with shortest-distance wiring. Connect GND of Cout to the GND pin with shortest-distance wiring.
- Make the GND plane wide.
- Ensure the PVIN and GND lines are firmly connected. A large switching current flows through the PVIN, GND, inductor, BOLX, BULX and Vout lines. If their impedance is too high, noise pickup or unstable operation may result.
- Connect the BOLX pin and the inductor and the BULX pin with shortest-distance wiring.


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## PCB LAYOUT CONSIDERATIONS

## Current Paths on PCB

Figure 1 and Figure 2 show the current pathways of step-up circuit when NMOSFET is turned on. Figure 3 and Figure 4 show the current pathways of step-down circuit when PMOSFET is turned on.
The currents flow in the directions of blue or green arrows. The parasitic components, such as impedance, inductance or capacitance, formed in the pathways indicated by the red arrows affect the stability of the system and become the cause of noise. Reduce the parasitic components as much as possible. The current pathways should be made by short and thick wirings.


Figure 1. NMOSFET-ON (Step-up)


Figure 3. NMOSFET-ON (Step-down)


Figure 2. PMOSFET-ON (Step-up)


Figure 4. PMOSFET-ON (Step-down)

## PCB LAYOUT



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## TYPICAL CHARACTERISTICS

Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.

2) Output Current vs. Efficiency (for Different Input Voltages)

RP602Z330x, MODE = H

3) Output Current vs. Output Voltage RP602Z330x, MODE $=\mathrm{H}$


RP602Z330x, MODE $=\mathrm{L}$


RP602Z330x, MODE = L

4) Temperature vs. Output Voltage RP602Z330x

6) Input Voltage vs. Output Current RP602Z330x, MODE = L

8) CE Start-up Waveform RP602Z330x, $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$, MODE $=\mathrm{H}$ lout $=0 \mathrm{~mA}$

5) Temperature vs. Standby Current RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}$

7) Temperature vs. Soft-start Time RP602Z330x


RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=5.5 \mathrm{~V}, \mathrm{MODE}=\mathrm{H}$
lout $=0 \mathrm{~mA}$


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RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}, \mathrm{MODE}=\mathrm{L}$ lout $=0 \mathrm{~mA}$

9) Vout Waveform

RP602Z270x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$, $\mathrm{MODE}=\mathrm{H}$
lout $=10 \mathrm{~mA}$


RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}, \mathrm{MODE}=\mathrm{H}$ lout $=10 \mathrm{~mA}$


RP602Z330x, $\mathrm{V}_{\text {IN }}=5.5 \mathrm{~V}, \mathrm{MODE}=\mathrm{L}$
lout $=0 \mathrm{~mA}$


RP602Z270x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}, \mathrm{MODE}=\mathrm{L}$
lout $=0 \mathrm{~mA}$


RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}, \mathrm{MODE}=\mathrm{L}$ lout $=0 \mathrm{~mA}$


RP602Z420x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$, MODE $=\mathrm{H}$ lout $=10 \mathrm{~mA}$

10) Load Transient Response Waveform RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$, MODE $=\mathrm{H}$
lout $=1 \mathrm{~mA} \longleftrightarrow 500 \mathrm{~mA}$


RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$, $\mathrm{MODE}=\mathrm{H}$ lout $=\mathbf{5 0} \mathbf{~ m A} \longleftrightarrow \mathbf{9 0 0} \mathrm{mA}$


RP602Z420x, $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}, \mathrm{MODE}=\mathrm{L}$
lout $=0 \mathrm{~mA}$


RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}, \mathrm{MODE}=\mathrm{L}$
lout $=1 \mathrm{~mA} \longleftrightarrow 500 \mathrm{~mA}$


RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}, \mathrm{MODE}=\mathrm{L}$
lout $=\mathbf{5 0} \mathbf{~ m A} \longleftrightarrow 900 \mathrm{~mA}$


## RP602x

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RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$, $\mathrm{MODE}=\mathrm{H}$ lout $=1000 \mathrm{~mA} \longleftrightarrow 1500 \mathrm{~mA}$

11) CE Turn off Waveform RP602Z330x, $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$, $\mathrm{MODE}=\mathrm{H}$ lout $=0 \mathrm{~mA}$

12) Input Transient Response Waveform RP602Z330x, MODE = H
lout $=500 \mathrm{~mA}, \mathrm{~V}_{\text {IN }}=2.5 \mathrm{~V} \longleftrightarrow 4.5 \mathrm{~V}$


RP602Z330x, $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$, MODE $=\mathrm{L}$ lout $=1000 \mathrm{~mA} \longleftrightarrow 1500 \mathrm{~mA}$


RP602Z330x, $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}, \mathrm{MODE}=\mathrm{L}$
lout $=0 \mathbf{~ m A}$


RP602Z330x, MODE = L
lout $=500 \mathrm{~mA}, \mathrm{~V}_{\text {IN }}=2.5 \mathrm{~V} \longleftrightarrow 4.5 \mathrm{~V}$


The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-9.

Measurement Conditions

| Item | Measurement Conditions |
| :--- | :--- |
| Environment | Mounting on Board (Wind Velocity $=0 \mathrm{~m} / \mathrm{s}$ ) |
| Board Material | Glass Cloth Epoxy Plastic (Four-Layer Board) |
| Board Dimensions | $101.5 \mathrm{~mm} \times 114.5 \mathrm{~mm} \times 1.6 \mathrm{~mm}$ |
| Copper Ratio | Outer Layers (First and Fourth Layers): $60 \%$ <br> Inner Layers (Second and Third Layers): $100 \%$ |

Measurement Result
$\left(\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{Tjmax}=125^{\circ} \mathrm{C}\right)$

| Item | Measurement Result |
| :--- | :---: |
| Power Dissipation | 1400 mW |
| Thermal Resistance $(\theta j \mathrm{ja})$ | $\theta \mathrm{ja}=\left(125-25^{\circ} \mathrm{C}\right) / 1.4 \mathrm{~W}=71^{\circ} \mathrm{C} / \mathrm{W}$ |

日ja: Junction-to-Ambient Thermal Resistance


Power Dissipation vs. Ambient Temperature


Measurement Board Pattern


WLCSP-20-P1 Package Dimensions (Unit: mm)

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

## Measurement Conditions

| Item | Measurement Conditions |
| :--- | :--- |
| Environment | Mounting on Board (Wind Velocity $=0 \mathrm{~m} / \mathrm{s}$ ) |
| Board Material | Glass Cloth Epoxy Plastic (Four-Layer Board) |
| Board Dimensions | $76.2 \mathrm{~mm} \times 114.3 \mathrm{~mm} \times 0.8 \mathrm{~mm}$ |
| Copper Ratio | Outer Layer (First Layer): Less than 95\% of 50 mm Square <br> Inner Layers (Second and Third Layers): Approx. 100\% of 50 mm Square <br> Outer Layer (Fourth Layer): Approx. $100 \%$ of 50 mm Square |
| Through-holes | $\quad 0.3 \mathrm{~mm} \times 23 \mathrm{pcs}$ |

Measurement Result
$\left(\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{Tjmax}=125^{\circ} \mathrm{C}\right)$

| Item | Measurement Result |
| :--- | :---: |
| Power Dissipation | 3100 mW |
| Thermal Resistance ( $\theta \mathrm{ja}$ ) | $\theta \mathrm{ja}=32^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Characterization Parameter ( $\psi \mathrm{j} \mathrm{t})$ | $\psi j \mathrm{j}=8^{\circ} \mathrm{C} / \mathrm{W}$ |

日ja: Junction-to-Ambient Thermal Resistance
$\psi j$ t: Junction-to-Top Thermal Characterization Parameter


Power Dissipation vs. Ambient Temperature


Measurement Board Pattern


DFN(PLP)2730-12 Package Dimensions (Unit: mm)

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[^0]:    ${ }^{(1)}$ The pin numbers sharing the same pin symbol must be connected together: $\mathrm{A} 4, \mathrm{~B} 4$, and C 4 of the BOLX pin, $\mathrm{A} 2, \mathrm{~B} 2$, and C2 of the BULX pin, A5, B5, and C5 of the VOUT pin. D1 of the AVIN pin and A1, B1, and C1 of the PVIN pin must be connected together.
    ${ }^{(2)}$ D4 of the AGND pin and A3, B3, and C3 of the PGND pin must be connected to the ground.
    ${ }^{(3)}$ The logic to the MODE pin should not be changed while $\mathrm{CE}=\mathrm{H} \mathrm{H}$ ".

[^1]:    ${ }^{(1)}$ The AVIN pin and the PVIN pin must be connected together.
    ${ }^{(2)}$ The AGND pin and the PGND pin must be connected to the ground.
    ${ }^{(3)}$ The logic to the MODE pin should not be changed while CE = "H".

[^2]:    ${ }^{(1)}$ Refer to POWER DISSIPATION for detailed information

[^3]:    ${ }^{(1)}$ Place Cin as close as possible to the PVIn pin.
    ${ }^{(2)}$ Place Cout as close as possible to the Vout pin.

